



STM1001

Reset Circuit

FEATURES SUMMARY

- PRECISION MONITORING OF 3V, 3.3V, and 5V SUPPLY VOLTAGES
- OPEN DRAIN $\overline{\text{RST}}$ OUTPUT
- 140ms RESET PULSE WIDTH (MIN)
- LOW SUPPLY CURRENT - 6 μ A (TYP)
- GUARANTEED $\overline{\text{RST}}$ ASSERTION DOWN TO $V_{\text{CC}} = 1.0\text{V}$
- OPERATING TEMPERATURE:
-40°C to 85°C (Industrial Grade)
- LEAD-FREE, SMALL SOT23 PACKAGE

Figure 1. Logic Diagram

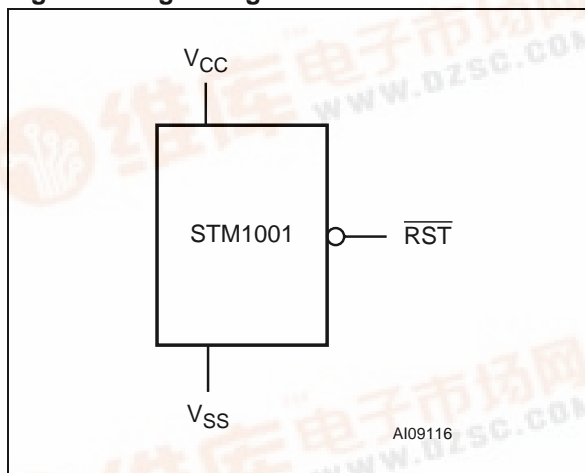


Figure 2. Package



Table 1. Signal Names

V_{SS}	Ground
$\overline{\text{RST}}$	Active-Low RESET Output (Open Drain)
V_{CC}	Supply Voltage

Figure 3. SOT23-3 Connections

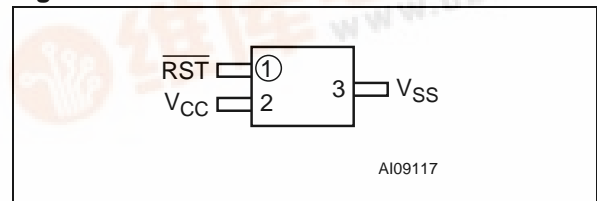


TABLE OF CONTENTS

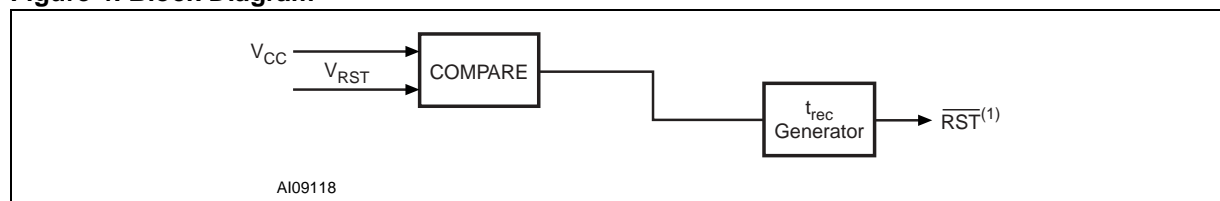
FEATURES SUMMARY	1
Figure 1. Logic Diagram	1
Figure 2. Package	1
Table 1. Signal Names	1
Figure 3. SOT23-3 Connections	1
SUMMARY DESCRIPTION	3
Figure 4. Block Diagram	3
Figure 5. Hardware Hookup	3
OPERATION	4
Reset Output	4
Negative-Going V_{CC} Transients	4
Valid /RST Output Down to $V_{CC} = 0V$	4
TYPICAL OPERATING CHARACTERISTICS	5
Figure 6. Supply Current vs. Temperature, L/M/R/S/T (no load)	5
Figure 7. Power-down Reset Delay vs. Temperature - $V_{OD} = V_{TH} - V_{CC}$ (L/M)	5
Figure 8. Power-down Reset Delay vs. Temperature - $V_{OD} = V_{TH} - V_{CC}$ (R/S/T)	6
Figure 9. Power-up t_{rec} vs. Temperature	6
Figure 10. Normalized Reset Threshold vs. Temperature	7
Figure 11. Max Transient Duration NOT Causing Reset Pulse vs. Reset Comparator Overdrive	7
MAXIMUM RATING	8
Table 2. Absolute Maximum Ratings	8
DC and AC PARAMETERS	8
Table 3. Operating and AC Measurement Conditions	8
Figure 12. AC Testing Input/Output Waveforms	8
Table 4. DC and AC Characteristics	9
PACKAGE MECHANICAL	10
Figure 13. SOT23-3 – 3-lead Small Outline Transistor Package Outline	10
Table 5. SOT23-3 – 3-lead Small Outline Transistor Package Mechanical Data	10
PART NUMBERING	11
Table 6. Ordering Information Scheme	11
Table 7. Marking Description	11
REVISION HISTORY	12
Table 8. Document Revision History	12

SUMMARY DESCRIPTION

The STM1001 MICROPROCESSOR RESET Circuit is a low-power supervisory device used to monitor power supplies. It performs a single function: asserting a reset signal whenever the V_{CC}

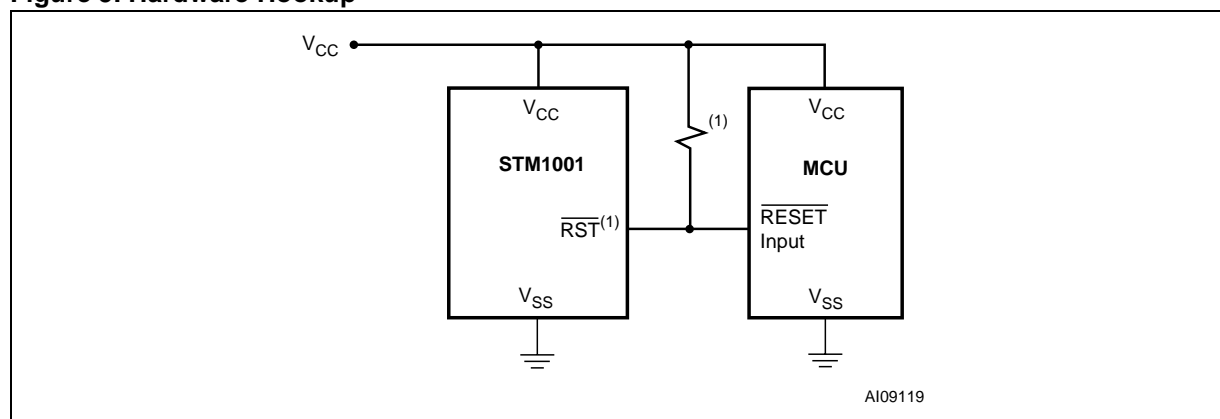
supply voltage drops below a preset value and keeping it asserted until V_{CC} has risen above the preset threshold for a minimum period of time (t_{rec}).

Figure 4. Block Diagram



Note: 1. Open Drain

Figure 5. Hardware Hookup



Note: 1. \overline{RST} output requires pull-up resistor.

OPERATION

Reset Output

The STM1001 MICROPROCESSOR RESET CIRCUIT asserts a reset signal to the MCU whenever V_{CC} goes below the reset threshold (V_{RST}). \overline{RST} is guaranteed valid down to $V_{CC} = 1V$ (0° to $70^\circ C$).

During power-up, once V_{CC} exceeds the reset threshold an internal timer keeps \overline{RST} low for the reset time-out period, t_{rec} . After this interval, \overline{RST} returns high.

If V_{CC} drops below the reset threshold, \overline{RST} goes low. Each time \overline{RST} is asserted, it stays low for at least the reset time-out period. Any time V_{CC} goes below the reset threshold, the internal timer clears. The reset timer starts when V_{CC} returns above the reset threshold. The active-low reset (\overline{RST}) is an open drain output.

Negative-Going V_{CC} Transients

The STM1001 is relatively immune to negative-going V_{CC} transients (glitches). [Figure 11., page 7](#) shows typical transient duration versus reset comparator overdrive (for which the STM1001 will NOT generate a reset pulse). The graph was generated using a negative pulse applied to V_{CC} , starting at 0.5V above the actual reset threshold

and ending below it by the magnitude indicated (comparator overdrive). The graph indicates the maximum pulse width a negative V_{CC} transient can have without causing a reset pulse. As the magnitude of the transient increases (further below the threshold), the maximum allowable pulse width decreases. Any combination of duration and overdrive which lies under the curve will NOT generate a reset signal. Typically, a V_{CC} transient that goes 100mV below the reset threshold and lasts 20 μs or less will not cause a reset pulse. A 0.1 μF bypass capacitor mounted as close as possible to the V_{CC} pin provides additional transient immunity.

Valid \overline{RST} Output Down to $V_{CC} = 0V$

When V_{CC} falls below 1V, the \overline{RST} output no longer sinks current, but becomes an open circuit. In most systems this is not a problem, as most MCUs do not operate below 1V. However, in applications where \overline{RST} output must be valid down to 0V, a pull-down resistor may be added to hold the \overline{RST} output low. This resistor must be large enough to not load the \overline{RST} output, and still be small enough to pull the output to ground. A 100K Ω resistor is recommended.

TYPICAL OPERATING CHARACTERISTICS

Note: Typical values are at $T_A = 25^\circ\text{C}$, $V_{CC} = 5\text{V}$ for L/M versions, $V_{CC} = 3.3\text{V}$ for T/S versions, and $V_{CC} = 3.0\text{V}$ for R versions.

Figure 6. Supply Current vs. Temperature, L/M/R/S/T (no load)

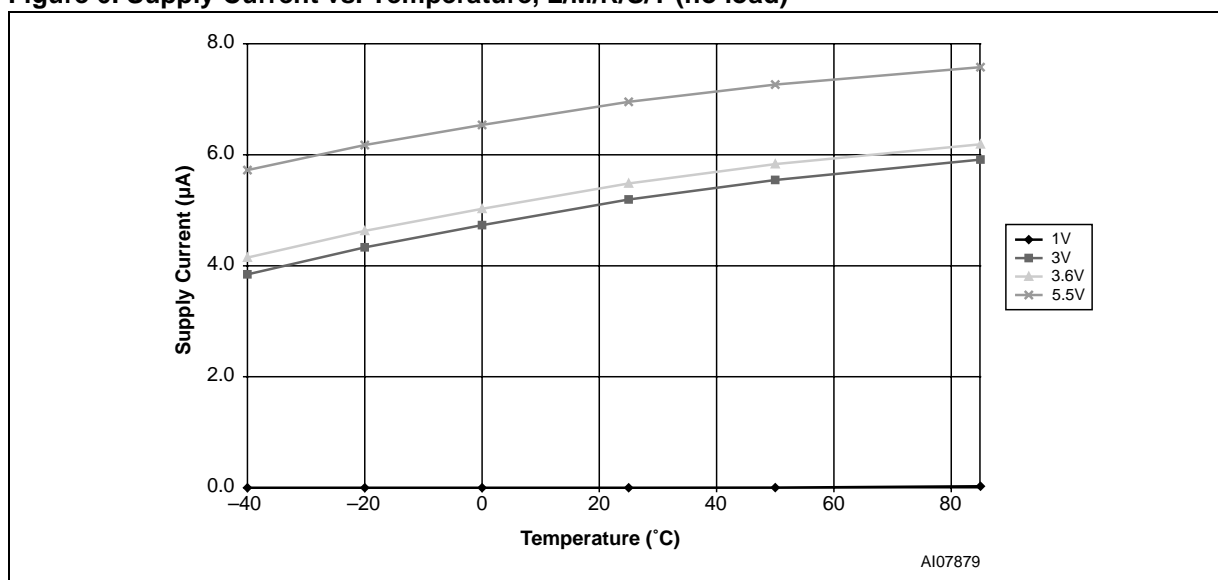


Figure 7. Power-down Reset Delay vs. Temperature - $V_{OD} = V_{TH} - V_{CC}$ (L/M)

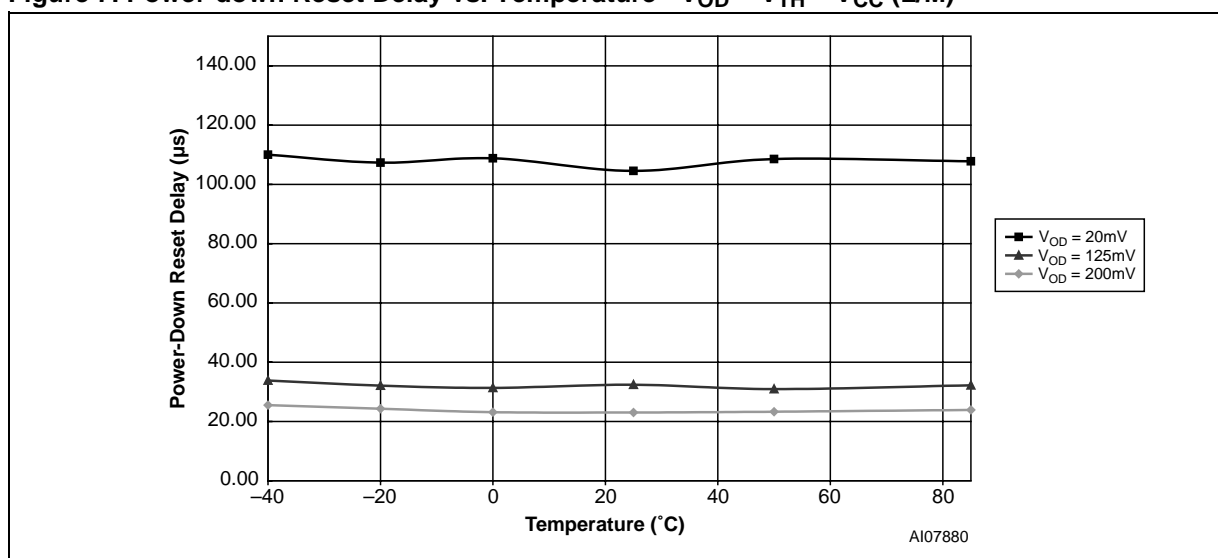


Figure 8. Power-down Reset Delay vs. Temperature - $V_{OD} = V_{TH} - V_{CC}$ (R/S/T)

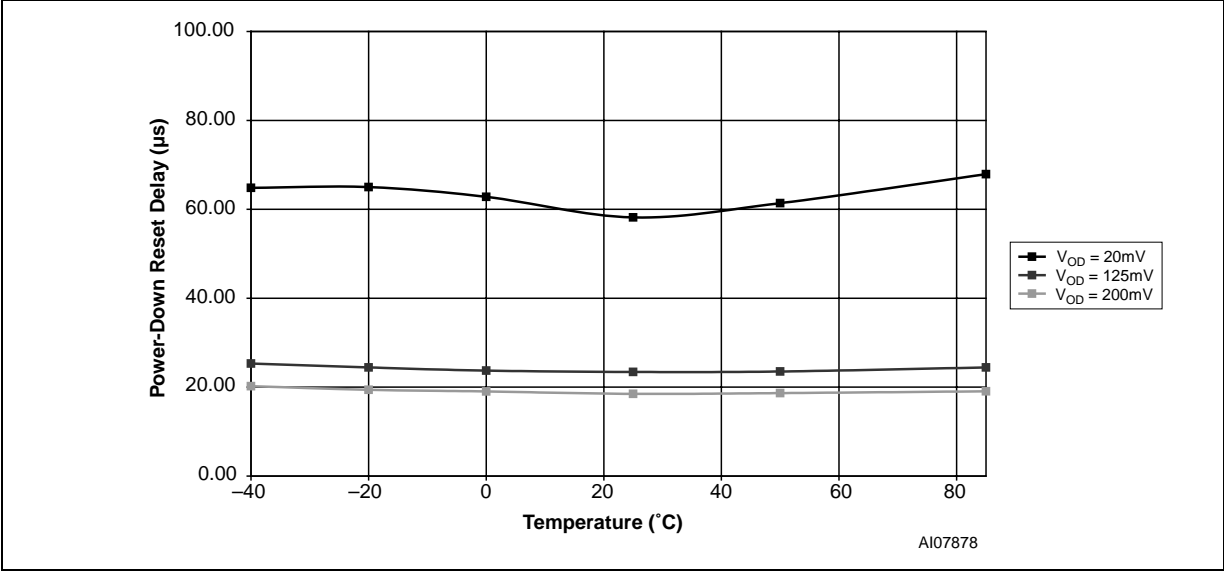


Figure 9. Power-up t_{rec} vs. Temperature

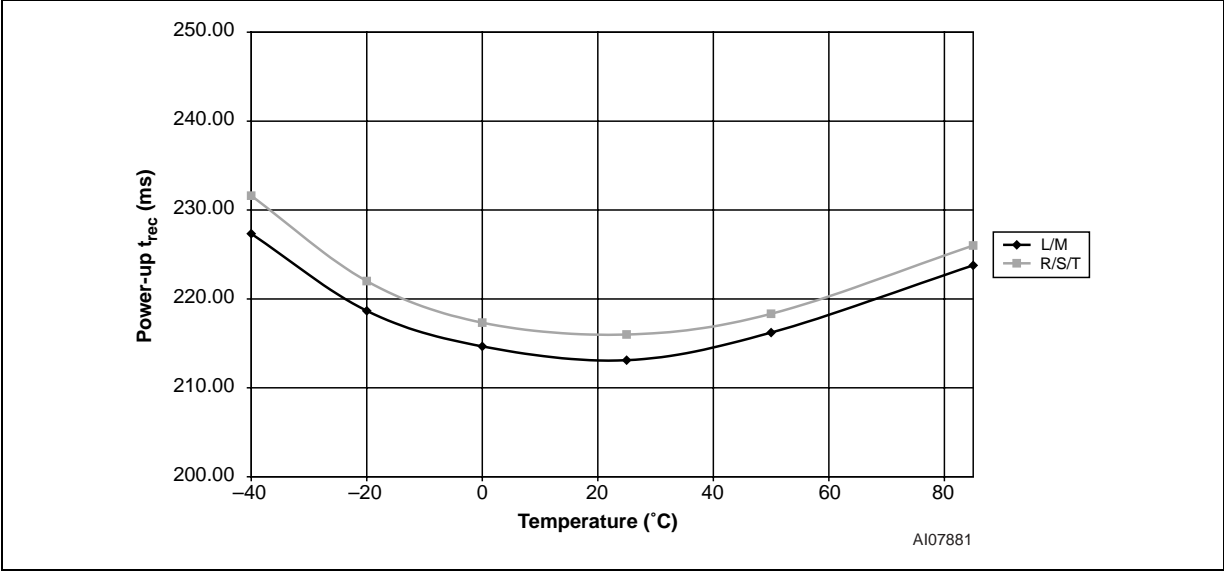


Figure 10. Normalized Reset Threshold vs. Temperature

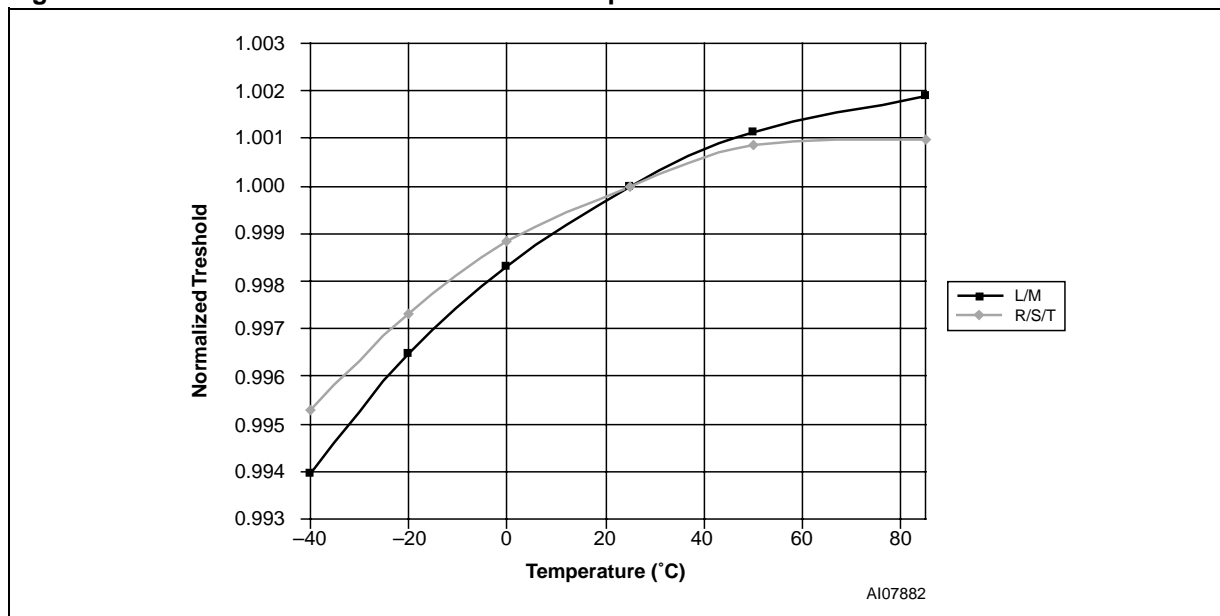
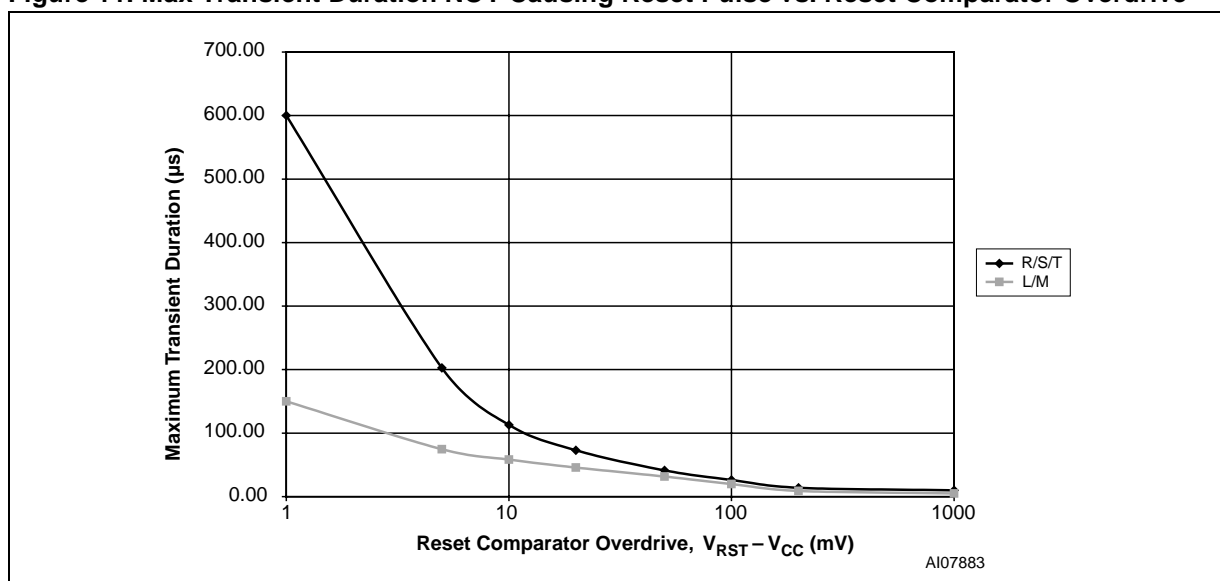


Figure 11. Max Transient Duration NOT Causing Reset Pulse vs. Reset Comparator Overdrive



MAXIMUM RATING

Stressing the device above the rating listed in the Absolute Maximum Ratings table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not im-

plied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Table 2. Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
T_{STG}	Storage Temperature (V_{CC} Off)	-55 to 150	°C
$T_{SLD}^{(1)}$	Lead Solder Temperature for 10 seconds	260	°C
V_{IO}	Input or Output Voltage	-0.3 to $V_{CC} + 0.3$	V
V_{CC}	Supply Voltage	-0.3 to 7.0	V
I_O	Output Current	20	mA
P_D	Power Dissipation	320	mW

Note: 1. Reflow at peak temperature of 255°C to 260°C for < 30 seconds (total thermal budget not to exceed 180°C for between 90 to 150 seconds).

DC AND AC PARAMETERS

This section summarizes the operating measurement conditions, and the DC and AC characteristics of the device. The parameters in the DC and AC characteristics Tables that follow, are derived from tests performed under the Measurement

Conditions summarized in Table 3, Operating and AC Measurement Conditions. Designers should check that the operating conditions in their circuit match the operating conditions when relying on the quoted parameters.

Table 3. Operating and AC Measurement Conditions

Parameter	STM1001	Unit
V_{CC} Supply Voltage	1.0 to 5.5	V
Ambient Operating Temperature (T_A)	-40 to 85	°C
Input Rise and Fall Times	≤ 5	ns
Input Pulse Voltages	0.2 to $0.8V_{CC}$	V
Input and Output Timing Ref. Voltages	0.3 to $0.7V_{CC}$	V

Figure 12. AC Testing Input/Output Waveforms

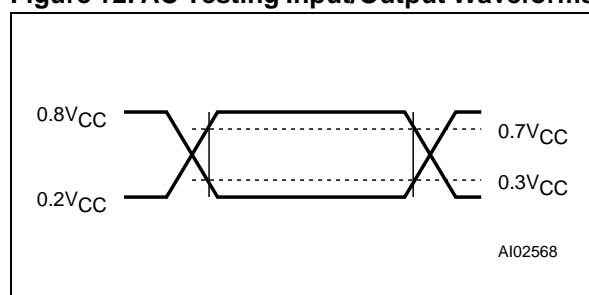


Table 4. DC and AC Characteristics

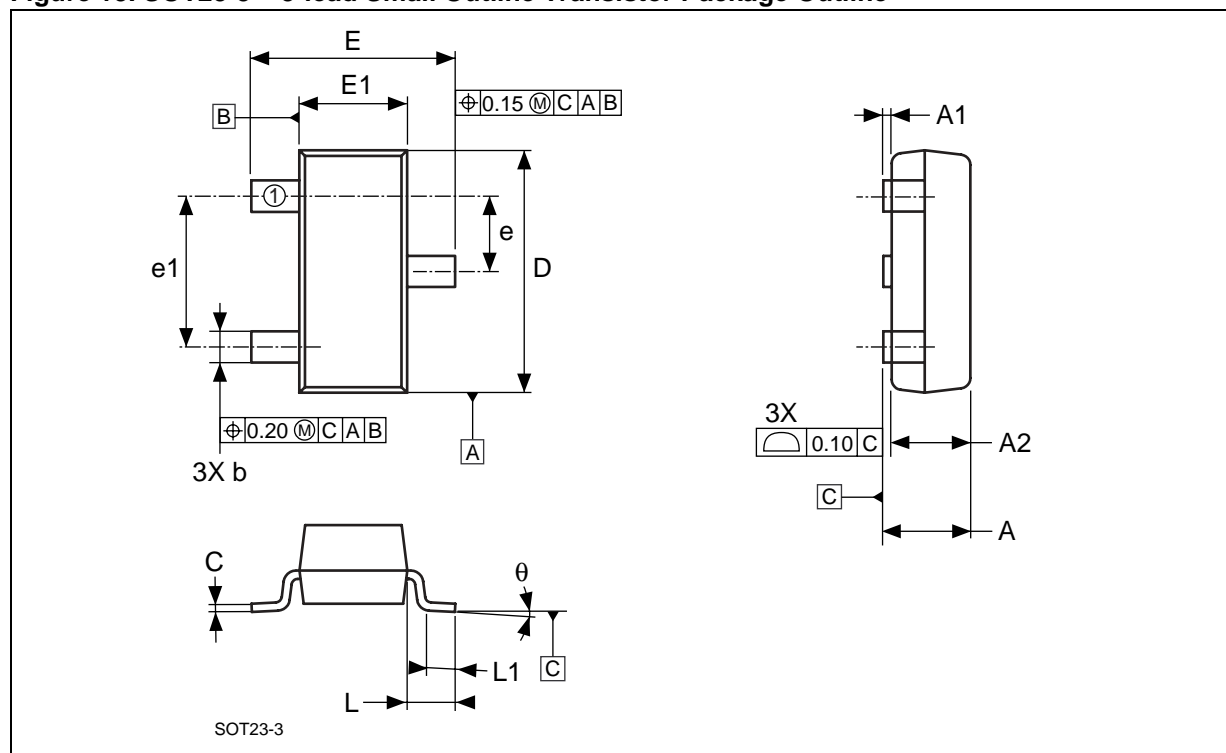
Sym	Alter- native	Description	Test Condition ⁽¹⁾		Min	Typ	Max	Unit
V _{CC}		Operating Voltage	T _A = −40 to +85°C		1.2		5.5	V
			T _A = 0 to +70°C		1.0		5.5	V
I _{CC}		V _{CC} Supply Current	V _{CC} < 3.6V			5.5	10	μA
			V _{CC} < 5.5V			7	15	μA
I _{LO}		Open Drain Reset Output Leakage Current	V _{CC} > V _{RST} , Reset not asserted		−1		+1	μA
V _{OL}		$\overline{\text{RST}}$ Output Low Voltage	STM1001R/S/T only, I _{OL} = 1.2mA V _{CC} = V _{RST} (min)				0.3	V
			STM1001L/M only, I _{OL} = 3.2mA V _{CC} = V _{RST} (min)				0.4	V
V _{OL}		$\overline{\text{RST}}$ Output Low Voltage	I _{OL} = 50μA; V _{CC} > 1.0V				0.3	V
RESET Thresholds								
V _{RST}		Reset Threshold	STM1001L	25°C	4.56	4.63	4.70	V
				−40 to 85°C	4.50		4.75	V
			STM1001M	25°C	4.31	4.38	4.45	V
				−40 to 85°C	4.25		4.50	V
			STM1001T	25°C	3.04	3.08	3.11	V
				−40 to 85°C	3.00		3.15	V
			STM1001S	25°C	2.89	2.93	2.96	V
				−40 to 85°C	2.85		3.00	V
		V _{RST} Temperature Coefficient		V _{CC} = 3.3V		45		ppm/ C
		V _{CC} to $\overline{\text{RST}}$ Delay	V _{CC} = V _{RST} to (V _{RST} − 100mV)	STM1001L/M		40		μs
				STM1001R/S/T		20		μs
	t _{rec}	$\overline{\text{RST}}$ Pulse Width			140	210	280	ms

Note: 1. Valid for Ambient Operating Temperature: T_A = -40 to 85°C; V_{CC} = 1.2V to 5.5V (except where noted).

2. "Glitches" of 100ns or less typically will not generate a RESET pulse.

PACKAGE MECHANICAL

Figure 13. SOT23-3 – 3-lead Small Outline Transistor Package Outline




Note: Drawing is not to scale.

Table 5. SOT23-3 – 3-lead Small Outline Transistor Package Mechanical Data

Symbol	mm			inches		
	Typ	Min	Max	Typ	Min	Max
A		0.89	1.12		0.035	0.044
A1		0.01	0.10		0.001	0.004
A2		0.88	1.02		0.035	0.042
b		0.30	0.50		0.012	0.020
C		0.08	0.20		0.003	0.008
D		2.80	3.04		0.110	0.120
E		2.10	2.64		0.083	0.104
E1		1.20	1.40		0.047	0.055
e		0.89	1.03		0.035	0.041
e1		1.78	2.05		0.070	0.081
L	0.54			0.021		
L1		0.40	0.60		0.016	0.024
θ		0°	8°		0°	8°
N	3			3		

PART NUMBERING

Table 6. Ordering Information Scheme

Example:	STM1001	L	WX	6	F
Device Type					
STM1001					
Reset Threshold Voltage					
L = $V_{RST} = 4.50V$ to $4.75V$					
M = $V_{RST} = 4.25V$ to $4.50V$					
T = $V_{RST} = 3.00V$ to $3.15V$					
S = $V_{RST} = 2.85V$ to $3.00V$					
R = $V_{RST} = 2.55V$ to $2.70V$					
Package					
WX = SOT23-3					
Temperature Range					
6 = -40 to $85^{\circ}C$					
Shipping Method					
F = Pb-Free Package (ECO  PACK [®]), Tape & Reel					

For other options, or for more information on any aspect of this device, please contact the ST Sales Office nearest you.

Table 7. Marking Description

Part Number	Reset Threshold	Output	Topside Marking ⁽¹⁾
STM1001L	4.63V	Open Drain \overline{RST}	8BAx
STM1001M	4.38V	Open Drain \overline{RST}	8BBx
STM1001T	3.08V	Open Drain \overline{RST}	8BCx
STM1001S	2.93V	Open Drain \overline{RST}	8BDx
STM1001R	2.63V	Open Drain \overline{RST}	8BEx

Note: 1. Lowercase "x" indicates date code.

REVISION HISTORY**Table 8. Document Revision History**

Date	Version	Revision Details
09-Dec-03	1.0	First Edition
19-Feb-04	2.0	Part number changed from STM6301
22-Mar-04	2.1	Update DC Characteristics (Table 4)
09-Apr-04	3.0	Device promoted; reformatted; marking updated (Table 7)
19-Nov-04	4.0	Update dimensions (Table 5)

Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

The ST logo is a registered trademark of STMicroelectronics.

All other names are the property of their respective owners

© 2004 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America
www.st.com